# TOSHIBA

TOSHIBA PHOTOCOUPLER GaAlAs IRED & PHOTO-IC

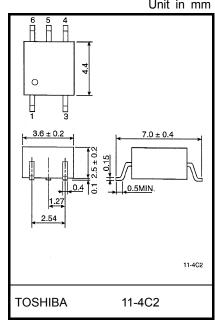
# Preliminary

# **TLP2066**

FA (Factory Automation) **High Speed Interface** 3.3V Supply Voltage

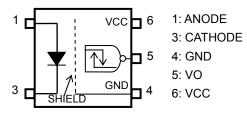
The Toshiba TLP2066 consists of a GaA{As light-emitting diode and an integrated high-gain, high-speed photodetector. TLP2066 operates with 3.3 V supply voltage. Toshiba provides the TLP116 for supply voltage 5V type.

- Inverter logic (totempole output)
- Package type : MFSOP6 •
- Guaranteed performance over temperature : -40~100°C
- Power supply voltage : 3.0~3.6V •
- Input thresholds current: IFHL=5mA (Max.) •
- Propagation delay time (tpHL/tpLH): 60ns (Max.) •
- Switching speed : 20MBd(TYP.)(NRZ)
- Common mode transient immunity : 15kV/us
- Isolation voltage : 3750Vrms
- UL recognition: UL1577 under application •

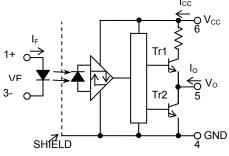


Weight: 0.09 g(Typ.)

#### **Pin Configuration (Top View)**







0.1uF bypass capacitor must be connected between pins 6 and 4

#### **Truth Table**

Input	LED	Tr1	Tr2	Output
Н	ON	OFF	ON	L
L	OFF	ON	OFF	Н

Unit in mm

## Absolute Maximum Ratings (Ta=25°C)

	Characteristic	Symbol	Rating	Unit
	Forward current	١ <sub>F</sub>	I <sub>F</sub> 25	
ED	Forward current derating (Ta≥85°C)	ΔIF/ΔTa	-0.7	mA/°C
ш	Peak transient forward current (Note1)	I <sub>FPT</sub>	1	А
	Reverse voltage	VR	6	V
2	Output current	l <mark>o</mark> 10		mA
DETECTOR	Output voltage	VO	6	V
ETE(	Supply voltage	VCC	6	V
D	Output power dissipation	PO	40	mW
Oper	ating temperature range	Topr	-40~100	°C
Stora	ige temperature range	Tstg	-55~125	°C
Lead	solder temperature(10s)	Tsol	260	°C
	tion voltage C,1min.,R.H.≤60%,Ta=25°C) (Note2)	BVs	3750	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note1: Pulse width PW≤1us, 300pps.

Note2: This device is regarded as a two terminal device: pins 1 and 3 are shorted together, as are pins 4, 5 and 6.

# **Recommended Operating Conditions**

Characteristi	Symbol	Min	Тур.	Max	Unit	
Input current , ON		lF(ON)	8		18	mA
Input voltage , OFF		VF(OFF)	0		0.8	V
Supply voltage(*)	(Note3)	V <sub>CC</sub>	3.0	3.3	3.6	V

(\*) This item denotes operating ranges, not meaning of recommended operating conditions.

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Note3: The detector of this product requires a power supply voltage (VCC) of 3.0 V higher for stable operation. If the VCC is lower than this value, an ICCH may increase, or an output may be unstable. Be sure to use the product after checking the supply current, and the operation of a power-on/-off.

Note 4: A ceramic capacitor(0.1 µF) should be connected from pin 6 to pin 4 to stabilize the operation of the high gain linear amplifier. Failure to provide the bypass may impair the switching property. The total lead length between capacitor and coupler should not exceed 1 cm.

# **Electrical Characteristics**

# (Unless otherwise specified, Ta=-40~100°C, VCC=3.0~3.6 V)

Characteristic	Symbol	Test Circuit	Conditions	Min.	Тур.	Max.	Unit
Input forward voltage	VF	_	I <sub>F</sub> =10mA ,Ta=25°C	1.45	1.6	1.85	V
Temperature coefficient of forward voltage	ΔV <sub>F</sub> /ΔTa		I <sub>F</sub> =10mA		2	_	mV/°C
Input reverse current	IR	—	V <sub>R</sub> =6V,Ta=25°C	_	—	10	μA
Input capacitance	CT	_	V=0,f=1MHz,Ta=25°C	_	60	_	pF
Logic low output voltage	V <sub>OL</sub>	1	I <sub>OL</sub> =1.6mA, I <sub>F</sub> =12mA	_	_	0.6	V
Logic high output voltage	VOH	2	I <sub>OH</sub> =-0.02mA, V <sub>F</sub> =1.05V	2.0	—	—	v
Logic low supply current	ICCL	3	I <sub>F</sub> =12mA, VCC=3.3V	—	—	5.0	mA
Logic high supply current	Іссн	4	V <sub>F</sub> =0V, VCC=3.3V (Note 3)	_	_	5.0	mA
Supply voltage	VCC			3.0	_	3.6	V
Input current logic low output	IFHL		I <sub>O</sub> =1.6mA,V <sub>O</sub> <0.6V			5	mA
Input voltage logic high output	VFLH		I <sub>O</sub> =-0.02mA,V <sub>O</sub> >2.0V	0.8			V

\*All typical values are at Ta=25°C, VCC=3.3V, IF (ON) =12mA unless otherwise specified

# Isolation Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Capacitance input to output	CS	Vs = 0, f = 1MHz (Note 2)	_	0.8	_	pF
Isolation resistance	R <sub>S</sub>	R.H. ≤ 60%,V <sub>S</sub> = 500V (Note 2)	1×10 <sup>12</sup>	10 <sup>14</sup>	_	Ω
		AC,1 minute	3750	_	_	V
Isolation voltage	BVS	AC,1 second,in oil	_	10000	_	V <sub>rms</sub>
		DC,1 minute,in oil	_	10000		Vdc

Note 4: A ceramic capacitor(0.1 μF) should be connected from pin 6 to pin 4 to stabilize the operation of the high gain linear amplifier. Failure to provide the bypass may impair the switching property. The total lead length between capacitor and coupler should not exceed 1 cm.

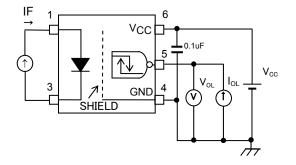
#### Switching Characteristics (Unless otherwise specified, Ta=-40~100°C, VCC=3.3V)

Characteristic	Symbol	Test Circuit	Conditions		Min.	Тур.	Max.	Unit
Propagation delay time to logic high output	tpHL	5	I <sub>F</sub> =0→12mA	R <sub>IN</sub> =100Ω	_		60	ns
Propagation delay time to logic low output	tpLH	5	I <sub>F</sub> =12→0mA	C <sub>L</sub> =15pF (Note 5)	_	_	60	ns
Propagation delay time to logic high output	tpHL		V <sub>IN</sub> =0→3.3V (I <sub>F</sub> =0→8mA)	R <sub>IN</sub> =220Ω C <sub>IN=</sub> 47pF C <sub>L</sub> =15pF (Note 5)	_		60	ns
Propagation delay time to logic low output	tpLH	6	V <sub>IN</sub> =3.3→0V (I <sub>F</sub> =8→0mA)		_	_	60	ns
Switching time dispersion between ON and OFF	tpHL- tpLH		I <sub>F</sub> =12mA , R <sub>IN</sub> = CL=15pF (Note		_	_	30	ns
Output fall time (90-10%)	tf	5	I <sub>F</sub> =0→12mA	R <sub>IN</sub> =100 Ω C <sub>L</sub> =15pF (Note 5)		4		ns
Output rise time (10-90%)	tr	]	I <sub>F</sub> =12→0mA			5	_	ns
Common mode transient immunity at high Level output	СМ <sub>Н</sub>	7	V <sub>CM</sub> =1000Vp-p Vo(Min)=2V,Ta=		15000			V/μs
Common mode transient immunity at low level output	СМГ	7	V <sub>CM</sub> =1000Vp-p,I <sub>F</sub> =12mA, Vo(Max)=0.8V,Ta=25°C		-15000	_	_	V/μs

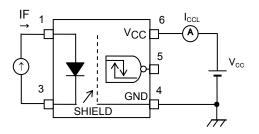
\*All typical values are at Ta=25°C

Note 5: CL is approximately 15pF which includes probe and Jig/stray wiring capacitance.

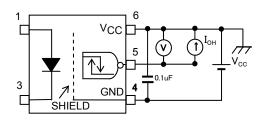
#### **TEST CIRCUIT 1: VOL**



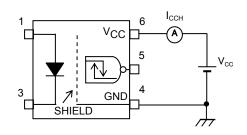
#### **TEST CIRCUIT 3: ICCL**



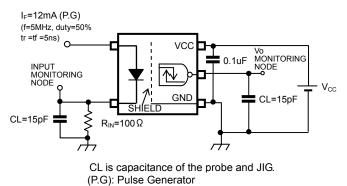
#### **TEST CIRCUIT 2: VOH**

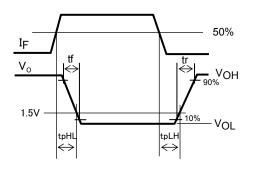


#### **TEST CIRCUIT 4: ICCH**

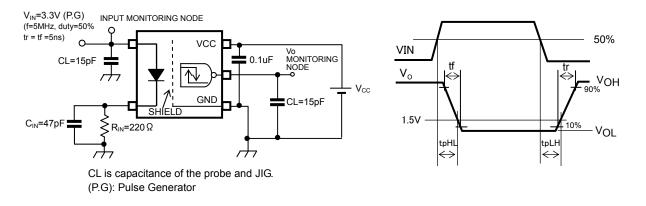


## TEST CIRCUIT 5: tpHL , tpLH

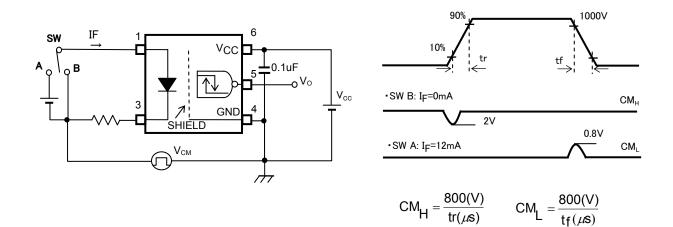




#### TEST CIRCUIT 6: tpHL, tpLH



#### TEST CIRCUIT 7: Common-Mode Transient Immunity Test Circuit



#### **RESTRICTIONS ON PRODUCT USE**

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